264194US90PCT



JC02 Rec'd PCT/PTC 04 APR 2009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Tomohisa TAKAHASHI

SERIAL NO:

10/518,548

GAU:

FILED:

January 3, 2005

EXAMINER:

FOR:

MANUFACTURING METHOD OF HONEYCOMB STRUCTURAL BODY, AND SEALING MATERIAL

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- □ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number <u>15-0030</u>. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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Form PTO 1449 U.S. DEPARTMENT OF COMMERCE (Modified) PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO.		SERIAL NO.				
		264194US90PCT		10/518,548				
				APPLICANT				
LIST OF	REFE	RENCES CITED BY API	PLICANT	Tomohisa TAKAHASHI				
				FILING DATE		GROUP		
				January 3, 2005				
				U.S. PATENT DOCUMENTS				
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	NAME CLASS		SUB FILING DATE CLASS IF APPROPRIATE	
	AA	5,930,994	08/03/99	SHIMATO et al.				
	AB	5,914,187	06/22/99	NARUSE et al.				
	AC	6,447,564	09/10/02	OHNO et al.				
	AD	6,669,751	12/30/03	OHNO et al.				
	AE	6,565,630	05/20/03	OHNO et al.				
	AF	US 2004-0031264 A1	02/19/04	KOJIMA				
	AG	US 2004-0033175 A1	02/19/04	OHNO et al.				
	АН	US 2004-0161596 A1	08/19/04	TAOKA et al.				
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	AL	US 2005-0016141 A1	01/27/05	HONG et al.				
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	AN	US 2005-0011174 A1	01/20/05	HONG et al.	:			
			FO	REIGN PATENT DOCUMENTS				
	DOCUMENT DATE COUNTRY TRANS				TRANS	LATION		
		NUMBER	DATE	COOMIN	COONTIC		YES NO	
	AO	2000-5671	01/11/00	JP (with English abstract)				NO
	AP	2000-102709	04/11/00	JP (with English abstract)				NO
	AQ							
	AR							
	AS						6	
	AT							
	AU							
	AV							
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)								
	AW							
	AX							
	AY							
	AZ		-		Addi	tional Refe	rences	sheet(s) attached
Examiner					Date Co	nsidered		
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.								
			. •					

U.S. PCT Application Serial No.: 10/518,548 Docket No.: 264194US90PCT

STATEMENT OF RELEVANCY

the		have been cited in the International Search Report. Coping submitted herewith only when not automatically provider ching Authority.	
		have been cited in the corresponding Search Reposes is being submitted herewith.	port.
	References <u>AC</u> erences is being sub	o, AP are discussed in the specification. A copy of the mitted here with.	iese
		are additional prior art known to Applicant. A copy of g submitted herewith.	f

LIST OF RELATED CASES

Docket Number	Serial or Patent Number	Filing or Issue Date	Patent Appl. <u>Publication No.</u>	Inventor/ Applicant
PER CLIENT	5,930,994	08/03/99		SHIMATO et al.
PER CLIENT	5,914,187	06/22/99		NARUSE et al.
PER CLIENT	6,447,564	09/10/02		OHNO et al.
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^{*}Present Application; listed for information

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^{*}Present Application; listed for information MM/gyy I:\EM\EMREL\263s-264s\264194US LIST.DOC